

Agilent N5183A MXG Microwave Analog Signal Generator

Data Sheet

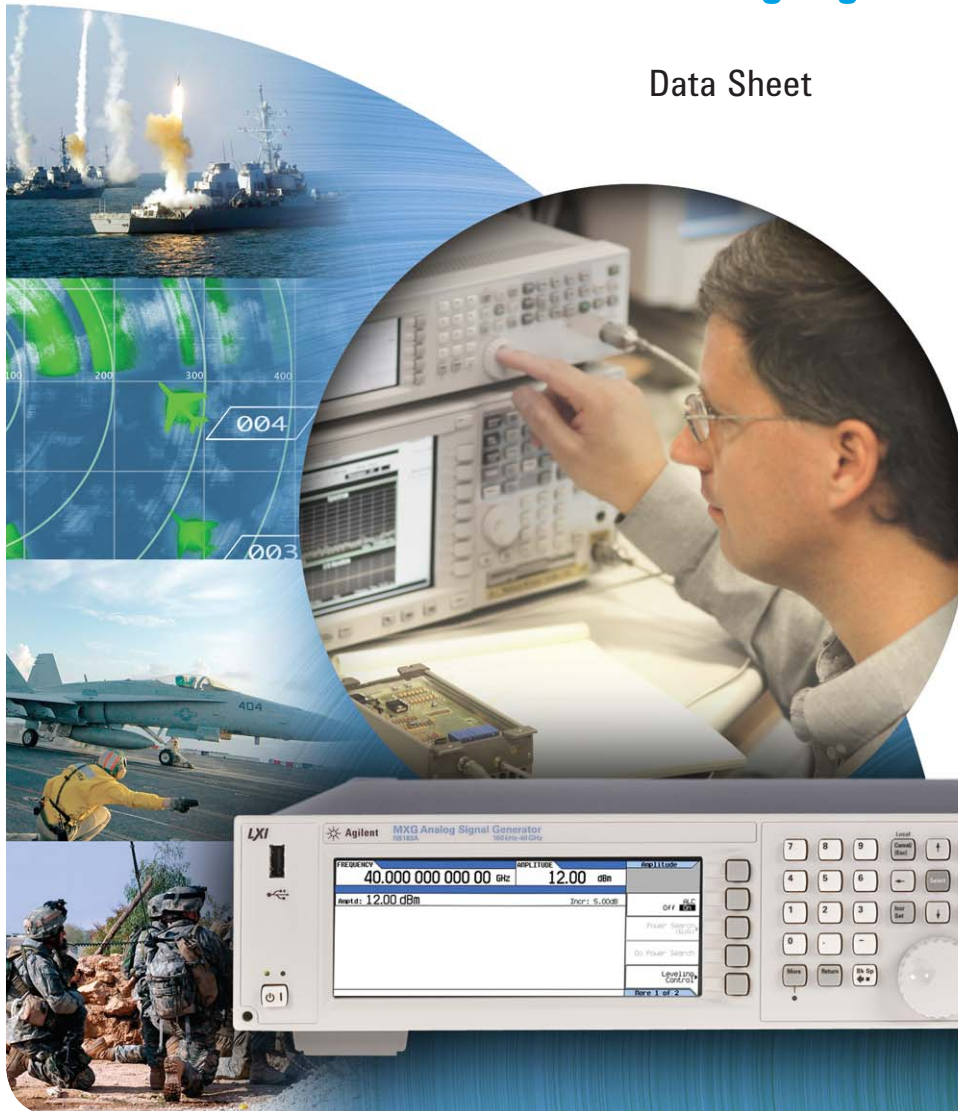


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Definitions

Specification (spec): Represents warranted performance of a calibrated instrument that has been stored for a minimum of 2 hours within the operating temperature range of 0 to 55 °C, unless otherwise stated, and after a 45 minute warm-up period. The specifications include measurement uncertainty. Data represented in this document are specifications unless otherwise noted.

Typical (typ): Represents characteristic performance, which 80% of the instruments manufactured will meet. This data is not warranted, does not include measurement uncertainty, and is valid only at room temperature (approximately 25 °C).

Nominal (nom): The expected mean or average performance, or an attribute whose performance is by design, such as the 50 Ω connector. This data is not warranted and is measured at room temperature (approximately 25 °C).

Measured (meas): An attribute measured during the design phase for purposes of communicating expected performance, such as amplitude drift vs. time. This data is not warranted and is measured at room temperature (approximately 25 °C).

Note: All graphs contain measured data from several units at room temperature unless otherwise noted.

Frequency

Range	
Option 520	100 kHz to 20 GHz
Option 532	100 kHz to 31.8 GHz
Option 540	100 kHz to 40 GHz
Minimum frequency	100 kHz ¹
Resolution	0.01 Hz
Phase offset	Adjustable in nominal 0.01° increments

Frequency switching speed^{2,3}

Type	Standard	Option UNZ
SCPI mode	≤ 5 ms	≤ 1.15 ms, 750 μs (typ)
List/Step sweep mode	≤ 5 ms	≤ 900 μs, 600 μs (typ)

Stability	± aging rate ± temperature effects ± line voltage effects
Internal time base reference oscillator aging rate	< ±1 ppm/yr
Temperature effects	± 1 ppm (typ) (0 to 55 °C)
Line voltage effects	± 0.1 ppm (nom)
Line voltage range	5% to -10% (nom)

Reference output	
Frequency	10 MHz
Amplitude	≥ +4 dBm (nom) into 50 Ω load

External reference input

	Fixed	Variable (Option 1ER)
Input frequency	10 MHz	1 to 50 MHz
Lock range	± 10 Hz	
Amplitude	> -3.5 to 20 dBm (nom)	
Impedance	50 Ω (nom)	

Digital sweep

Operating modes	Step sweep (equally or logarithmically spaced frequency steps) List sweep (arbitrary list of frequency steps) Can also simultaneously sweep amplitude. See amplitude section for more detail.
Sweep range	Within instrument frequency range
Dwell time	100 μs to 100 s
Number of points	2 to 65535 (step sweep) 1 to 1601 (list sweep)
Step change	Linear or logarithmic
Triggering	Free run, trigger key, external, timer, bus (GPIB, LAN, USB)

1. Performance below 250 kHz is unspecified, except as indicated.
2. Time from receipt of SCPI command or trigger signal to within 0.1 ppm of final frequency or within 100 Hz, whichever is greater, and amplitude settled to within 0.2 dB.
3. Specification does not apply when switching to or from frequencies < 500 kHz, when ALC level is < -5 dBm for Option 540 or < 0 dBm for Option 520, or when frequency crosses 0.002, 0.02, 0.1, 2.0, 3.2, 20.0, 25.6, or 32.0 GHz.

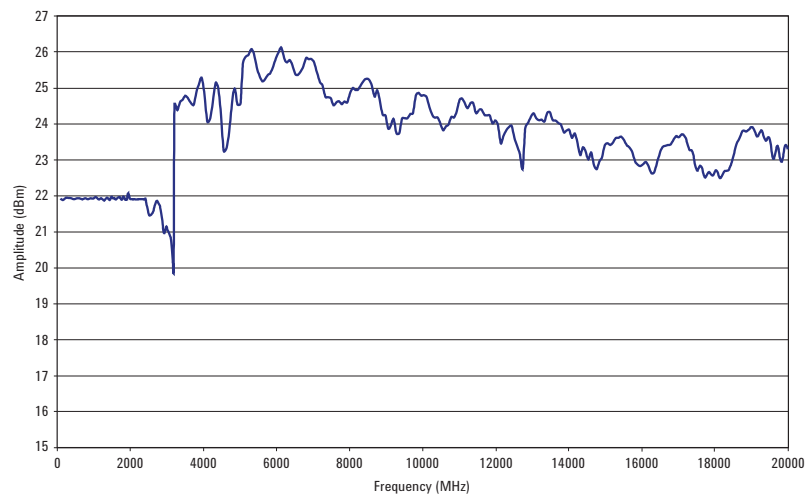
Maximum output power¹

Range	Standard ²	Option 1EA ³
Option 520		
100 to 250 kHz	+11	+14
> 250 kHz to 3.2 GHz	+11	+15
> 3.2 to 20 GHz	+11	+18
Options 532 and 540		
100 to 250 kHz	+11	+14
250 kHz to 3.2 GHz	+7	+14
> 3.2 to 17 GHz	+7	+15
> 17 to 31.8 GHz	+7	+13
> 31.8 to 40 GHz	+7	+12

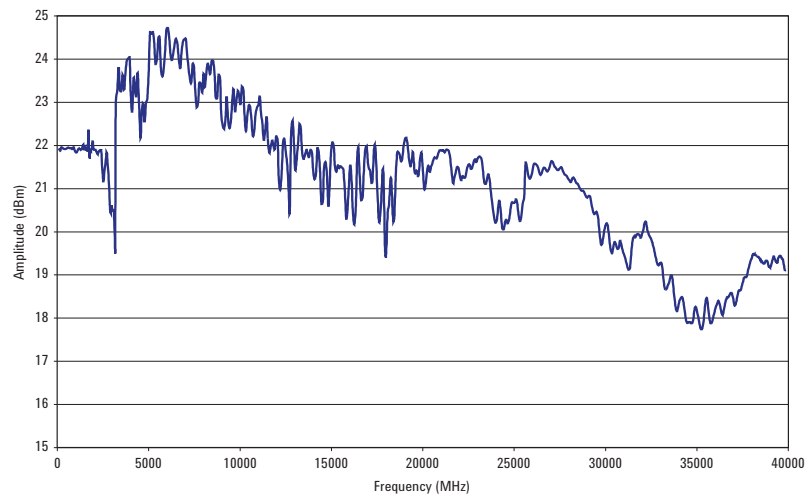
Minimum output power

Standard -20 dBm
 Option 1E1 -90 dBm⁴

Maximum available power Option 520 with Option 1EA (measured)



Maximum available power Option 540 with Option 1EA (measured)



1. Quoted specifications between 15 and 35 °C. Maximum output power typically decreases by 0.2 dB/ °C for temperatures outside this range.
2. Settable power +2 dB higher than specified.
3. Settable power +30 dBm.
4. Settable to -130 dBm.

Resolution 0.01 dB

Step attenuator (Option 1E1) 0 to 115 dB in 5 dB steps

Amplitude hold range -15 to maximum specified output power with step attenuator in 0 dB. Can be offset using Option 1E1 mechanical attenuator.

Amplitude switching speed^{1, 2}

Type	Standard
SCPI mode	2 ms (typ)
List/Step sweep mode	2 ms (typ)

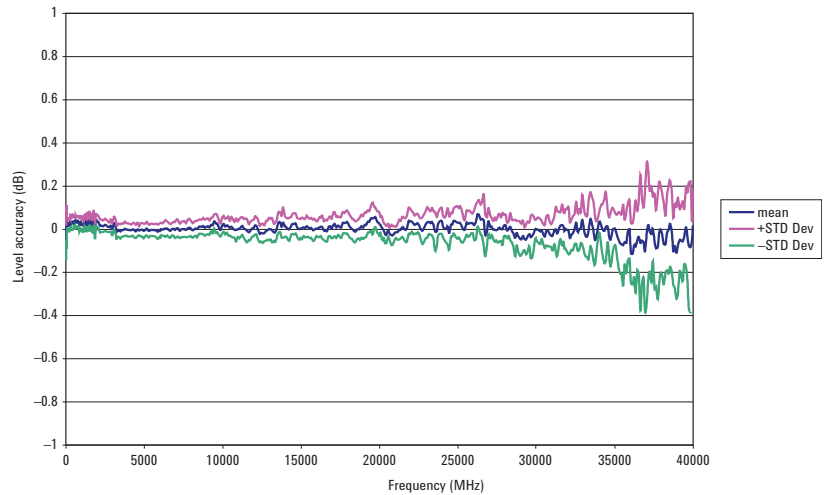
Absolute level accuracy [dB]^{3, 4}

Frequency range	-20 to < -10 dBm	-10 to +10 dBm	> +10 dBm
250 kHz to 2 GHz	±1.4	±0.6	±0.6
2 to 20 GHz	±1.3	±0.9	±0.9
20 to 40 GHz	±1.3	±0.9	±1.0

Absolute level accuracy with Option 1E1 (dB)⁴

Frequency range	-90 to < -75 dBm	-75 to < -10 dBm	-10 to +10 dBm	> +10 dBm
250 kHz to 2 GHz	±1.4	±0.7	±0.6	±0.6
2 to 20 GHz	±1.6	±1.0	±0.9	±0.9
20 to 40 GHz	±2.0	±1.1	±0.9	±1.0

Measured level accuracy Options 520 & 540 at -90 dBm



1. Time from receipt of SCPI command or trigger signal to amplitude settled within 0.2 dB.
2. Specification does not apply when switching from and to amplitudes where ALC levels are < -5 dBm for Option 540 or < 0 dBm for Option 520.
3. Level accuracy applies from -20 dBm to maximum output power between 15 °C and 35 °C.
4. For temperatures outside this range, absolute level accuracy degrades by 0.01 dB/degree C for frequencies ≤ 4.5 GHz and 0.02 dB/degree C for frequencies > 4.5 GHz. For instruments with Type-N connectors (Option 1E1), specifications are degraded typically 0.2 dB above 18 GHz. Specifications do not apply above the maximum specified power.

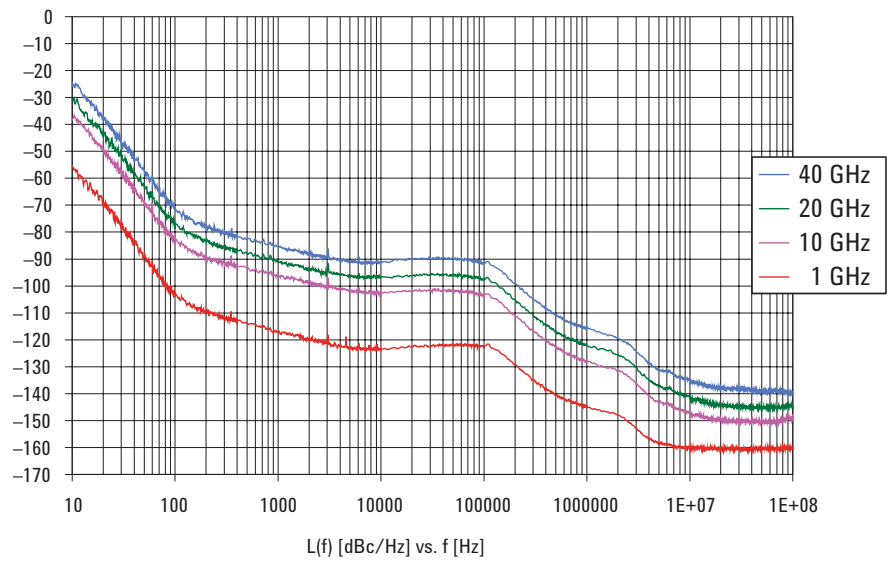
Temperature stability	0.01 dB/°C (typ) for temperatures < 20 °C or > 30 °C
User flatness correction	
Number of points	2 to 1601
Number of tables	10000 maximum; dependent on available free memory in instrument
Entry modes	USB/LAN direct power meter control, LAN to GPIB and USB to GPIB, remote bus and manual USB/GPIB power meter control
SWR	
100 kHz to 20 GHz	1.6:1 (typ)
> 20 to 40 GHz	1.8:1 (typ)
Leveling modes	Internal, external detector, ALC off, search
External detector leveling¹	
Range	-0.2 mV to -0.5V (nom)
Bandwidth	10 kHz (typ)
Digital sweep modes	
Operating modes	Step sweep (evenly spaced amplitude steps) List sweep (arbitrary list of amplitude steps) Can also simultaneously sweep frequency. See frequency section for more detail.
Sweep range	Within instrument amplitude range
Dwell time	100 μs to 100 s
Number of points	2 to 65535 (step sweep) 1 to 1601 (list sweep)
Step change	Linear
Triggering	Free run, trigger key, external, timer, bus (GPIB, LAN, USB)

1. Not intended for pulsed operation.

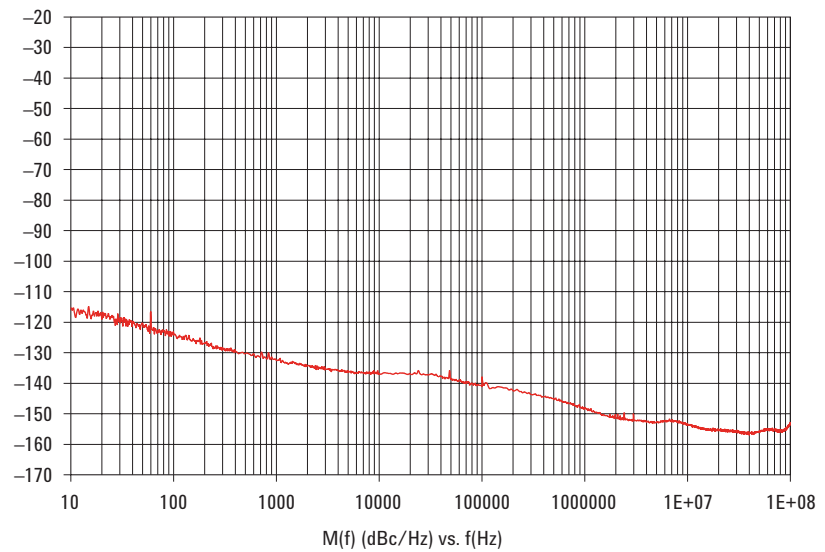
Single sideband phase noise (at 20 kHz offset from carrier)

Frequency range	dBc/Hz	dBc/Hz (typ)
250 kHz to < 250 MHz	-113	-116
250 to < 375 MHz	-125	-128
375 to < 750 MHz	-119	-122
750 MHz to < 1.5 GHz	-113	-116
1.5 to < 3.0 GHz	-107	-110
3.0 to < 6.0 GHz	-101	-104
6.0 to < 12.0 GHz	-95	-98
12.0 to < 24.0 GHz	-89	-92
24.0 to 40.0 GHz	-83	-86

SSB Phase Noise



AM noise at 10 GHz



Residual FM (CW mode, 0.3 to 3 kHz bandwidth, CITT, RMS)
< N*5Hz (typ)

Broadband noise CW mode at +10 dBm or maximum specified output power, whichever is lower for offsets > 10 MHz

0.25 to 10 GHz	-145 dBc/Hz (typ)
10 to 20 GHz	-135 dBc/Hz (typ)
20 to 40 GHz	-130 dBc/Hz (typ)

Harmonics (dBc)¹

250 kHz to 2 GHz	-28 (-30 typ)
> 2 to 20 GHz	-54 (-60 typ)
> 20 to 40 GHz	-56 (typ)

Non-harmonics (dBc)¹

250 kHz to 250 MHz	-54 (-89 typ)
> 250 to 375 MHz	-61 (-86 typ)
> 375 to 750 MHz	-55 (-74 typ)
> 750 MHz to 1.5 GHz	-48 (-70 typ)
> 1.5 to 3.2 GHz	-47 (-68 typ)
> 3.2 to 6 GHz	-40 (-63 typ)
> 6 to 12 GHz	-33 (-57 typ)
> 12 to 24 GHz	-50 (typ)
> 24 to 40 GHz	-45 (typ)

Subharmonics (dBc)¹

250 kHz to 1.5 GHz	None
> 1.5 GHz to 20 GHz	-53
> 20 to 40 GHz	-50

1. CW mode at +10 dBm or maximum specified output power, whichever is lower.

Analog Modulation

Frequency bands¹

Frequency	N
250 kHz to < 250 MHz	1
250 to < 375 MHz	0.250
375 to < 750 MHz	0.500
750 to < 1.5 GHz	1
1.5 to < 3.0 GHz	2
3.0 to < 6.0 GHz	4
6.0 to < 12.0 GHz	8
12.0 to < 24.0 GHz	16
24.0 to 40 GHz	32

Frequency modulation

(Option UNT)

Maximum deviation	N x 10 MHz (nom)
Resolution	0.1% of deviation or 1 Hz, whichever is greater (nom)
Deviation accuracy	< ± 2% + 20 Hz
1 kHz rate, deviation is N x 100	

Modulation frequency response (at 100 kHz deviation)

	1 dB bandwidth	3 dB bandwidth
DC coupled	DC to 3 MHz (nom)	DC to 7 MHz (nom)
AC coupled	5 Hz to 3 MHz (nom)	5 Hz to 7 MHz (nom)

Carrier frequency accuracy ²	< ±0.2% of set deviation + (N x 1 Hz)
Distortion	< 0.4%
1 kHz rate, deviation is N x 100 kHz	
Sensitivity when using external input	+1V peak for indicated deviation (nom)

1. N is a factor used to help define frequency and phase modulation specifications within the document.
2. Specification valid for temperature changes of less than ± 5° C since last DCFM calibration.

Phase modulation

(Option UNT)

Modulation deviation and frequency response:

	Max deviation	3 dB bandwidth
Nominal bandwidth	N x 5 radians (nom)	DC to 1 MHz (nom)
High bandwidth mode	N x 0.5 radians (nom)	DC to 4 MHz (nom)
Resolution	0.1% of deviation	

Deviation accuracy 1 kHz rate, normal bandwidth mode	< +0.5% + 0.01 rad (typ)
Distortion 1 kHz rate, deviation normal bandwidth mode	< 0.2% (typ)
Sensitivity when using external input	+1V peak for indicated deviation (nom)

Amplitude modulation¹

(Option UNT)

AM Depth	Linear	Exponential
Maximum settable	90%	20 dB
Resolution	0.1% of depth (nom)	0.01 dB (nom)
Accuracy (1 kHz rate)	< ±4% of setting + 1% (typ)	<±(4% of setting + 0.2 dB) (typ)

Modulation rate (3 dB bandwidth, 30% depth)	
DC coupled	0 to 10 kHz (typ)
AC coupled	5 Hz to 10 kHz (typ)
Distortion (1 kHz rate, 30% depth)	< 2.0% (typ)
Sensitivity when using external input	+1V peak for indicated depth (nom)

1. AM is specified at carrier frequencies > 2 MHz, ALC on, and when AM envelope does not exceed max power or go below -15 dBm for Option 520 or -20 dBm for Option 540.

Pulse modulation¹

(Option UNU)

On/Off ratio	> 80 dB (typ) ²
Rise time	< 50 ns (typ)
Fall time	< 50 ns (typ)
Minimum width	
ALC on	≥ 2 μs (typ)
ALC off	≥ 500 ns (typ)
Resolution	20 ns (nom)
Pulse repetition frequency	
ALC on	DC to 500 kHz
ALC off	DC to 2 MHz
Level accuracy (relative to CW, ALC on or off)	< 1 dB (typ)
Video feedthrough	< 350 mV (typ)
Pulse overshoot	< 15% (nom)
Pulse compression	15 ns (typ)
Pulse delay	
RF delay (video to RF output)	10 ns (nom)
Video delay (ext input to video)	30 ns (nom)
External input	
Input impedance	50 ohm (nom)
Level	+1 V _{peak} = ON (nom)
Internal pulse generator	
Modes	Free-run, square, triggered, adjustable doublet, trigger doublet, gated, and external pulse
Square wave rate	0.1 Hz to 10 MHz, 0.1 Hz resolution (nom)
Pulse period	500 ns to 42 seconds (nom)
Pulse width	500 ns to pulse period – 10 ns (nom)
Resolution	10 ns (nom)
Adjustable trigger delay	– pulse period + 10 ns to pulse period to pulse width – 10 ns
Settable delay	Free run – 3.99 to 3.97 μs
Triggered	0 to 40 s
Resolution (delay, width, period)	10 ns (nom)
Pulse doublets	
1st pulse delay (relative to sync out)	0 to 42 s – pulse width – 10 ns
1st pulse width	500 ns to 42 s – delay – 10 ns
2nd pulse delay (relative to pulse 1)	0 to 42 s – (delay ₁ + width ²) – 10 ns
2nd pulse width	20 ns to 42 s – (delay ₁ + delay ²) – 10 ns

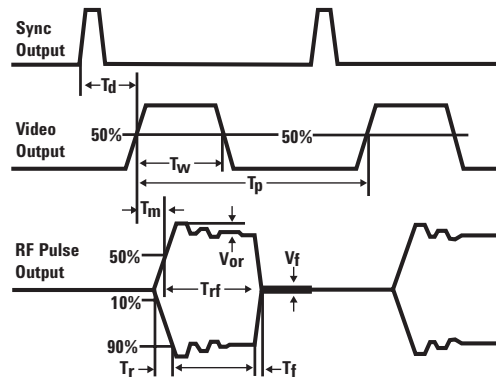
1. Pulse specifications apply to frequencies > 500 MHz. Operable down to 10 MHz.

2. Applies to power levels > –5 dBm for Option 1E1.

Narrow pulse modulation¹ (Option UNW)

	500 MHz to 3.2 GHz	Above 3.2 GHz
On/Off ratio	> 80 dB (typ)	> 80 dB (typ)
Rise/Fall times (Tr, Tf)	< 10 ns (7 ns)	< 10 ns (7 ns)
Minimum pulse width		
Internally leveled	≥ 2 us	≥ 2 us
ALC off ²	≥ 20 ns	≥ 20 ns
Repetition frequency		
Internally leveled	10 Hz to 500 kHz	10 Hz to 500 kHz
ALC off ²	DC to 5 MHz	DC to 10 MHz
Level accuracy relative to CW		
Internally leveled	< ±1.0 dB (typ)	< ±1.0 dB (typ)
ALC off ²	±1.0 dB (typ)	±1.0 dB (typ)
Width compression	< 5 ns (typ)	< 10 ns (typ)
RF width relative to video out		
Video feed-through ³	< 300 mV (typ)	< 10 mV (typ)
Video delay - ext input to video	30 ns (nom)	30 ns (nom)
RF delay -video to RF output	10 ns (nom)	20 ns (nom)
Pulse overshoot	< 15% (nom)	< 15% (nom)
Input level	+1 V _{peak} = RF On	+1 V _{peak} = RF On
Input impedance	50 Ω (nom)	50 Ω (nom)

T_d Video delay (variable)
T_w Video pulse width
(variable)
T_p Pulse period (variable)
T_m RF delay
T_{rf} RF pulse width
T_f RF pulse fall time
T_r RF pulse rise time
V_{or} Pulse overshoot
V_f Video feedthrough



1. Pulse specifications apply to frequencies > 500 MHz. Operable down to 10 MHz.
2. With power search on.
3. Applies to power levels < +10 dBm.

Internal analog modulation source

(Option UNT)

Waveform	Sine
Rate range	100 MHz to 2 MHz
Resolution	1 MHz
Frequency accuracy	Same as RF reference source (nom)

External modulation inputs

Modulation types	FM, AM, phase mod, pulse mod
Input impedance	50 Ω (nom)

Simultaneous modulation¹

All modulation types (FM, AM, ϕ M and pulse modulation) may be simultaneously enabled except: FM and phase modulation can not be combined; two modulation types can not be simultaneously generated using the same modulation source. For example, AM and FM can run concurrently and will modulate the output RF. This is useful for simulating signal impairments.

1. If AM or pulse modulation are on, then phase and FM specifications do not apply.

General Characteristics

Remote programming	
Interfaces	GPIB IEEE-488.2, 1987 with listen and talk LAN 100BaseT LAN interface, LXI class C compliant USB Version 2.0
Control languages	SCPI Version 1997.0
Compatibility languages supporting a subset of common commands Agilent Technologies	8360 series, E8247C, E8257C, E8257D, E8241A, E8244A, E8251A, E8254A, E4428C, E4438C, E8267C/D, 8662A, 8663A, 83711B, 83712B, 83731B, 83732B, 83751B, 83752B, 8340B, 8341B
Power requirements	100 to 120 VAC, 50 to 60 Hz 220 to 240 VAC, 50 to 60 Hz 250 W maximum
Operating temperature range	0 to 55 °C
Storage temperature range	-40 to 70 °C
Operating and storage altitude	15,000 feet
Environmental stress	Samples of this product have been type tested in accordance with the Agilent Environmental Test Manual and verified to be robust against the environmental stresses of Storage, Transportation and End-use; those stresses include but are not limited to temperature, humidity, shock, vibration, altitude and power line conditions. Test Methods are aligned with IEC 60068-2 and levels are similar to MIL-PRF-28800F Class 3.
Safety	Complies with European Low Voltage Directive 73/23/EEC, amended by 93/68/EEC • IEC/EN 61010-1 • Canada: CSA C22.2 No. 61010-1 • USA: UL 61010-1
EMC	Complies with European EMC Directive 89/336/ EEC, amended by 93/68/EEC • IEC/EN 61326 • CISPR Pub 11 Group 1, class A • AS/NZS CISPR 11:2002 • ICES/NMB-001
Memory	Memory is shared by instrument states, sweep list files, and other files. There is 512 MB of flash memory available in the N5181A MXG. Depending on how the memory is utilized, a maximum of 1000 instrument states can be saved.

Security (Option 006)	Memory sanitizing, memory sanitizing on power on, and display blanking.
Self test	Internal diagnostic routines test most modules in a preset condition. For each module, if its node voltages are within acceptable limits, the module "passes" the test.
Weight	≤ 13.8 kg (30 lb.) net, ≤ 28.4 kg (62 lb.) shipping
Dimensions	103 mm H x 426 mm W x 432 mm L (4.07 in H x 16.8 in W x 17 in L)
Recommended calibration cycle	24 months
ISO compliant	The Agilent N5181A MXG is manufactured in an ISO-9001 registered facility in concurrence with Agilent Technologies' commitment to quality.
Front panel connectors¹	
RF output Option 520	Output impedance 50 Ω (nom) Precision APC-3.5 male, or Type-N with Option 1ED
Option 532/540	Precision 2.4 mm male; plus 2.4 – 2.4 mm and 2.4 – 2.9 mm female adapters
USB 2.0	Used with a memory stick for transferring instrument states, licenses and other files into or out of the instrument. Also used with U2000 series USB average power sensors. For a current list of supported memory sticks, visit www.agilent.com/find/MXG , click on Technical Support, and refer to FAQs: WaveformDownloads and Storage.
Rear panel connectors¹	
RF output (Option 1EM)	Outputs the RF signal via a precision N type female connector.
Sweep out	Generates output voltage, 0 to +10 V when the signal generator is sweeping. This output can also be programmed to indicate when the source is settled or output pulse video and is TTL and CMOS compatible in this mode. Output impedance < 1 Ω, can drive 2k Ω. Damage levels are ±15 V.
AM	External AM input. Nominal input impedance is 50 Ω. Damage levels are ±5 V.
FM	External FM input. Nominal input impedance is 50 Ω. Damage levels are ±5 V.
Pulse	External pulse modulation input. This input is TTL and CMOS compatible. Low logic levels are 0 V and high logic levels are +1 V. Nominal input impedance is 50 Ω. Input damage levels are ≤ -0.3 V and ≥ +5.3 V.

1. All connectors are BNC unless otherwise noted.

Trigger in	Accepts TTL and CMOS level signals for triggering point-to-point in sweep mode. Damage levels are ≤ -0.3 V and $\geq +5.3$ V. Nominal input impedance is 50 Ω .
Trigger out	Outputs a TTL and CMOS compatible level signal for use with sweep mode. The signal is high at start of dwell, or when waiting for point trigger in manual sweep mode; low when dwell is over or point trigger is received. This output can also be programmed to indicate when the source is settled, pulse synchronization, or pulse video. Nominal output impedance is 50 ohms. Input damage levels are ≤ -0.3 V and $\geq +5.3$ V.
Reference input	Accepts a 10 MHz reference signal used to frequency lock the internal timebase. Option 1ER adds the capability to lock to a frequency from 1 MHz to 50 MHz. Nominal input level -3.5 to $+20$ dBm, impedance 50 Ω .
10 MHz out	Outputs the 10 MHz reference signal used by internal time base. Level is nominally $+3.9$ dBm. Nominal output impedance 50 Ω . Input damage level is $+16$ dBm.
USB 2.0	The USB connector provides remote programming functions via SCPI.
LAN (100 BaseT)	The LAN connector provides the same SCPI remote programming functionality as the GPIB connector. The LAN connector is also used to access the internal web server and FTP server. The LAN supports DHCP, sockets SCPI, VXI-11 SCPI, connection monitoring, dynamic host name services, TCP keep alive. This interface is LXI class C compliant.
GPIB	The GPIB connector provides remote programming functionality via SCPI.

Ordering Information

N5183A MXG microwave analog signal generator

Frequency

- 520 Frequency range from 100 kHz to 20 GHz
- 532 Frequency range from 100 kHz to 31.8 GHz
- 540 Frequency range from 100 kHz to 40 GHz

Performance enhancements

- UNZ Fast frequency switching
- 1E1 Step attenuator
- 1EA High power
- UNU Pulse modulation
- UNW Narrow pulse modulation
- UNT AM, FM, phase modulation
- 006 Instrument security
- 1ER Flexible reference input (1-50 MHz)
- 1EM Move RF output to rear panel
- 1ED Type N RF output connector

Accessories

- 1CM Rackmount kit
- 1CN Front handle kit
- 1CP Rackmount and front handle kit
- 1CR Rack slide kit
- AXT Transit case

Related Literature

Application literature

RF Source Basics, a self-paced tutorial (CD-ROM), literature number 5980-2060E

Product literature

Agilent MXG Signal Generator, Configuration Guide, literature number 5989-5485EN

See the Agilent MXG web page for the latest information. Get the latest news, product and support information, application literature, firmware upgrades and more at www.agilent.com/find/MXG



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